### Silicon N Channel MOS FET High Speed Power Switching

# HITACHI

ADE-208-478 1st. Edition

#### **Features**

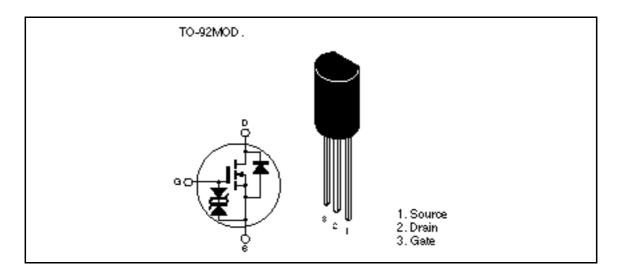
· Low on-resistance

$$R_{\rm DS(on)} = 0.055$$
  $\,$  typ. (at  $V_{\rm GS} = 10$  V,  $I_{\rm D} = 2.5$  A)

- 4V gate drive devices.
- Large current capacitance

$$I_D = 5 A$$

#### **Outline**





### Absolute Maximum Ratings ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	60	V
Gate to source voltage	V <sub>GSS</sub>	±20	V
Drain current	I <sub>D</sub>	5	A
Drain peak current	I <sub>D(pulse)</sub> *1	20	A
Body to drain diode reverse drain current	I <sub>DR</sub>	5	A
Avalanche current	I <sub>AP</sub> *3	5	A
Avalanche energy	E <sub>AR</sub> *3	2.14	mJ
Channel dissipation	Pch*2	0.9	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	−55 to +150 °C	

Notes: 1. PW 10µs, duty cycle 1 %

2. Value at Ta = 25°C

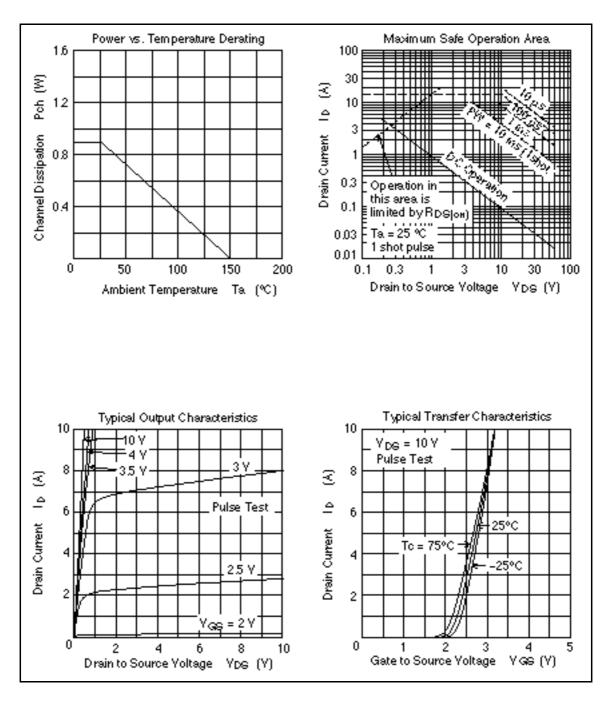
3. Value at Ta = 25°C, Rg 50

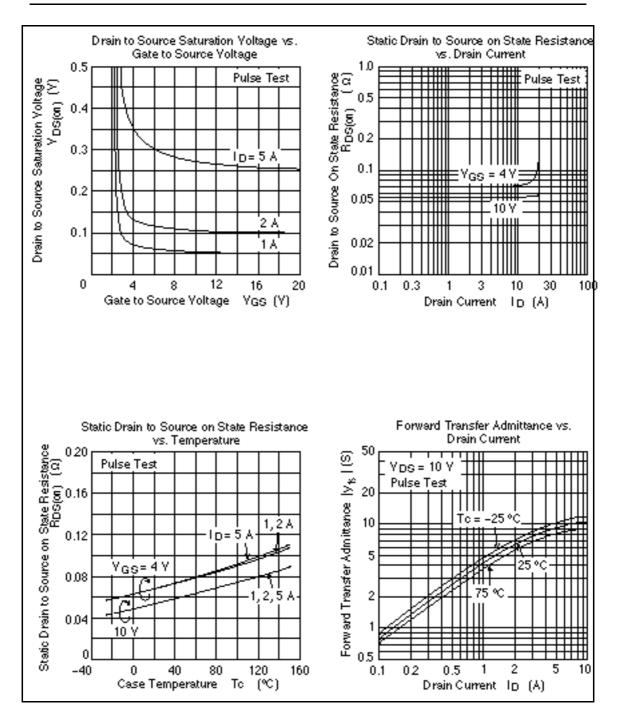
### Electrical Characteristics ( $Ta = 25^{\circ}C$ )

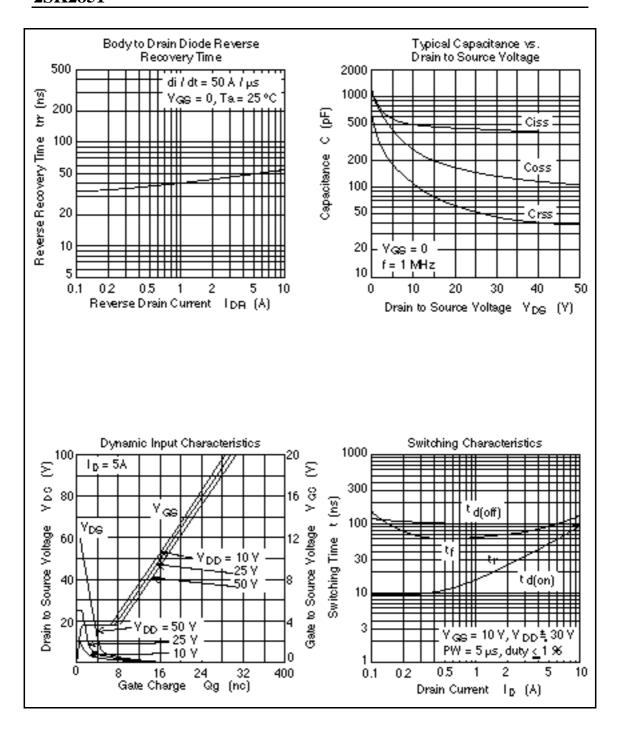
Item	Symbol	Min	Тур	Max	Unit	<b>Test Conditions</b>
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	_	_	V	$I_{D} = 10 \text{mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_{G} = \pm 100 \mu A, V_{DS} = 0$
Zero gate voltege drain current	I <sub>DSS</sub>	_	_	10	μΑ	$V_{DS} = 60 \text{ V}, V_{GS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 16V, V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	_	2.0	V	$I_D = 1 \text{mA}, V_{DS} = 10 \text{V}$
Static drain to source on state	R <sub>DS(on)</sub>	_	0.055	0.07		$I_D = 2.5A, V_{GS} = 10V^{*1}$
resistance	R <sub>DS(on)</sub>	_	0.07	0.1		$I_D = 2.5A, V_{GS} = 4V^{*1}$
Forward transfer admittance	y <sub>fs</sub>	5	7	_	S	$I_D = 2.5A, V_{DS} = 10V^{*1}$
Input capacitance	Ciss	_	500	_	pF	V <sub>DS</sub> = 10V
Output capacitance	Coss	_	260	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	110	_	pF	f = 1MHz
Turn-on delay time	t <sub>d(on)</sub>	_	10	_	ns	$V_{GS} = 10V, I_{D} = 2.5A$
Rise time	t <sub>r</sub>	_	30	_	ns	R <sub>L</sub> = 12
Turn-off delay time	$t_{d(off)}$	_	100	_	ns	_
Fall time	t <sub>f</sub>	_	75	_	ns	<del>_</del>
Body to drain diode forward voltage	$V_{DF}$	_	0.9	_	V	$I_{D} = 5A, V_{GS} = 0$
Body to drain diode reverse recovery time	t <sub>rr</sub>	_	50	_	ns	$I_F = 5A, V_{GS} = 0$ diF/ dt = 50A/µs

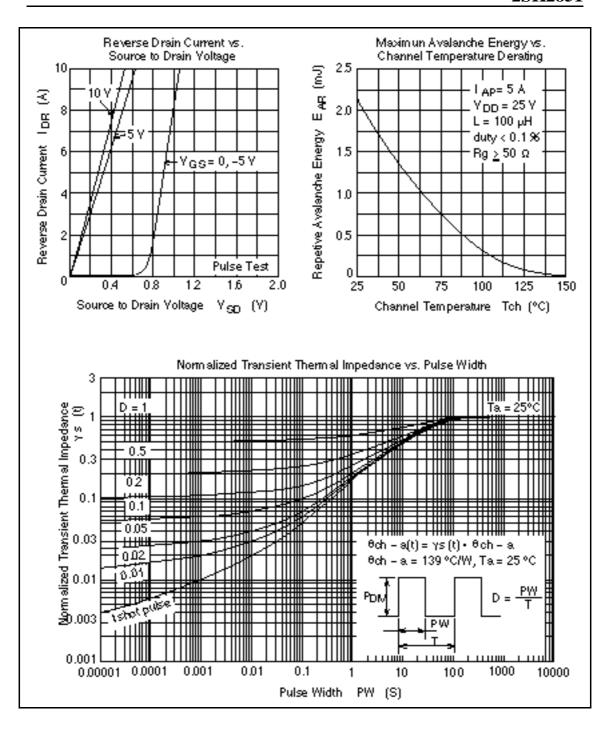
Note: 1. Pulse test

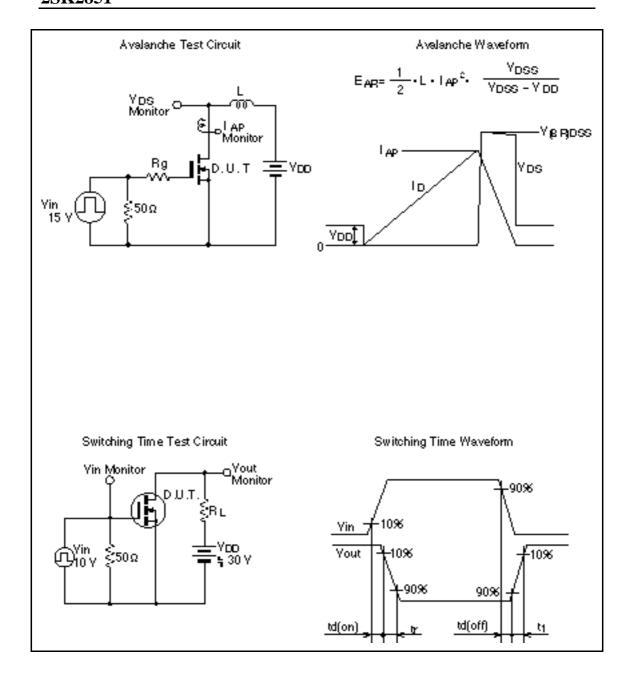
#### **Main Characteristics**





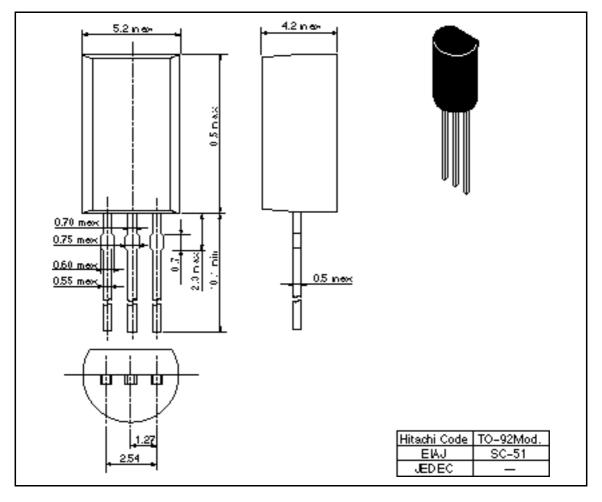






### **Package Dimentions**

Unit: mm



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